

	Discontinued Product
	is no longer in production. The device should not be or new design applications. Samples are no longer available.
Date of statu	us change: January 31, 2011
Recomme	ended Substitutions:
0	g customer transition, and for new customers or new applier to the <u>A1220, A1221, and A1223</u> .
	detailed information on purchasing options, contact your of field applications engineer or sales representative.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, revisions to the anticipated product life cycle plan for a product to accommodate changes in production capabilities, alternative product availabilities, or market demand. The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringements of patents or other rights of third parties which may result from its use.



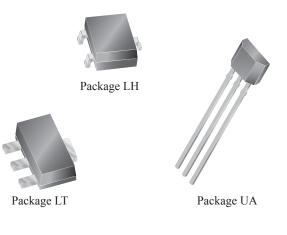
A3280, A3281, and A3283

Chopper-Stabilized, Precision Hall-Effect Latches

Features and Benefits

- Symmetrical switch points
- Resistant to physical stress
- Superior temperature stability
- Output short-circuit protection
- Operation from unregulated supply
- Reverse battery protection
- Solid-state reliability
- Small size

Packages:



Not to scale

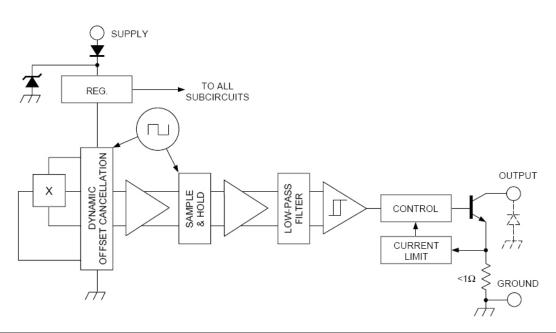
Description

The A3280, A3281, and A3283 Hall-effect latches are extremely temperature-stable and stress-resistant sensor ICs especially suited for operation over extended temperature ranges to+150°C. Superior high-temperature performance is made possible through dynamic offset cancellation, which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress. The three devices are identical except for magnetic switch points.

Each device includes on a single silicon chip a voltage regulator, Hall-voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and a short-circuit protected open-collector output to sink up to 25 mA. A south pole of sufficient strength will turn the output on. A north pole is necessary to turn the output off. An on-board regulator permits operation with supply voltages of 4.2 to 24 volts.

Three package styles provide a magnetically optimized package for most applications. Package type LH is a modified SOT23W surface-mount package, LT is a miniature SOT89/TO-243AA transistor package for surface-mount applications; while UA is a three-lead ultra-mini-SIP for through-hole mounting. Each package type is lead (Pb) free (suffix, -T), with 100% matte tin leadframe plating.

Functional Block Diagram



27609.20-DS, Rev. M

Selection Guide

Part Number	Packing*	Mounting	Ambient, T _A (°C)	B _{RP(MIN)} (T _A = 25°C) (G)	B _{OP(MAX)} (T _A = 25°C) (G)	
A3283ELTTR-T	7-in. reel, 1000 pieces/reel	SOT89 Surface Mount	-40 to 85			
A3283EUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole	-40 10 85			
A3283LLHLT-T	7-in. reel, 3000 pieces/reel	SOT23W Surface Mount		-180	180	
A3283LLTTR-T	7-in. reel, 1000 pieces/reel	SOT89 Surface Mount	-40 to 150			
A3283LUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole				

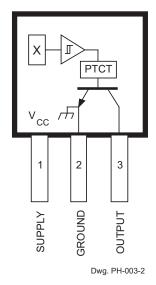


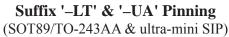
*Contact Allegro for additional packing options.

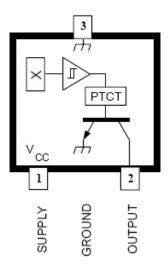
Absolute Maximum Ratings

Characteristic	Symbol	Symbol Notes		Units
Supply Voltage	V _{cc}		26.5	V
Reverse Battery Voltage	V _{RCC}		-30	V
Magnetic Flux Density	В		Unlimited	G
Output Off Voltage	V _{OUT}		26	V
Continuous Output Current	I _{OUT}	Internal current limiting is intended to protect the device from output short circuits.	25	mA
Reverse Output Currrent	I _{ROUT}		-50	mA
Operating Ambient Temperature	т.	Range E	-40 to 85	°C
	T _A	Range L	-40 to 150	°C
Maximum Junction Temperature	T _J (max)		165	°C
Storage Temperature	T _{stg}		-65 to 170	°C

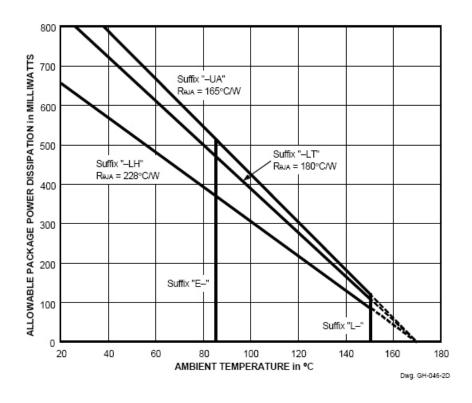








Suffix '–LH' Pinning (SOT23W)





				Limits				
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units		
Supply Voltage Range	V _{CC}	Operating, T _J < 170°C ¹	4.2	_	24	V		
Output Leakage Current	I _{OFF}	V_{OUT} = 24 V, B < B _{RP}	-	_	10	μA		
Output Saturation Voltage	V _{OUT(SAT)}	I _{OUT} = 20 mA, B > B _{OP}	-	185	500	mV		
Output Current Limit	I _{OM}	B > B _{OP}	30	_	60	mA		
Power-On Time	t _{po}	V _{CC} > 4.2 V	-	_	50	μs		
Chopping Frequency	f _C		_	340	_	kHz		
Output Rise Time	tr	R _L = 820 Ω, C _L = 20 pF	-	0.2	2.0	μs		
Output Fall Time	t _f	R _L = 820 Ω, C _L = 20 pF	-	0.1	2.0	μs		
Supply Current	I _{CC}	B < B _{RP} , V _{CC} = 12 V	-	3.0	8.0	mA		
		B > B _{OP} , V _{CC} = 12 V	-	4.0	8.0	mA		
Reverse Battery Current	I _{CC}	V _{RCC} = -30 V	-	_	-5.0	mA		
Zener Voltage	V _Z + V _D	I _{CC} = 15 mA, T _A = 25°C	28	32	37	V		
Zener Impedance	z _z + z _D	I _{CC} = 15 mA, T _A = 25°C	-	50	_	Ω		

ELECTRICAL CHARACTERISTICS over operating temperature range.

NOTES:

1. Maximum voltage must be adjusted for power dissipation and junction temperature.

2. B_{OP} = operate point (output turns on); B_{RP} = release point (output turns off).

3. Typical Data is at $T_A = +25^{\circ}C$ and $V_{CC} = 12$ V and is for design information only.

MAGNETIC CHARACTERISTICS over operating voltage range.

		Part Numbers ¹									
		A3280		A3281		A3283					
Characteristic	Test Conditions	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Operate Point, B _{OP}	at T_A = +25°C and T_A = max.	5.0	22	40	15	50	90	100	150	180	G
	at T _A = -40°C	5.0	_	40	15	_	90	100	_	200	G
Release Point, B _{RP}	at T_A = +25°C and T_A = max.	-40	-23	-5.0	-90	-50	-15	-180	-150	-100	G
	at T _A = -40°C	-40	_	-5.0	-90	_	-15	-200	_	-100	G
Hysteresis, B _{hys}	at T_A = +25°C and T_A = max.	10	45	80	30	100	180	_	300	360	G
$(B_{OP} - B_{RP})$	at T _A = -40°C	_	_	80	_	_	180	-	_	360	G

NOTES: 1. Complete part number includes a suffix to identify operating temperature range (E or L) and package type (LH, LT, or UA).
 2. As used here, negative flux densities are defined as less than zero (algebraic convention) and -50 G is less than +10 G.

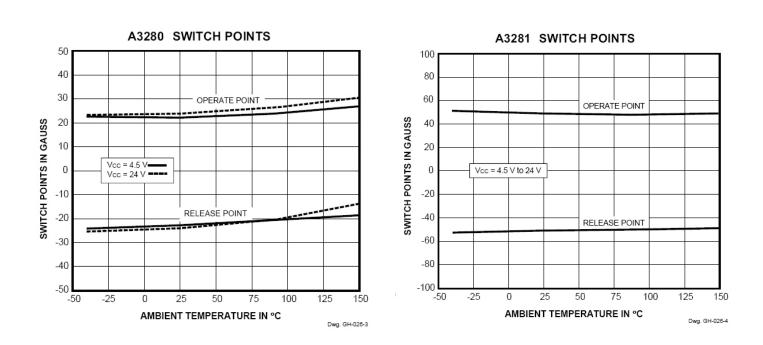
3. Typical Data is at TA = $+25^{\circ}$ C and VCC = 12 V and is for design information only.

4. 1 gauss (G) is exactly equal to 0.1 millitesla (mT).



A3280, A3281 and A3283

Chopper-Stabilized, Precision Hall-Effect Latches



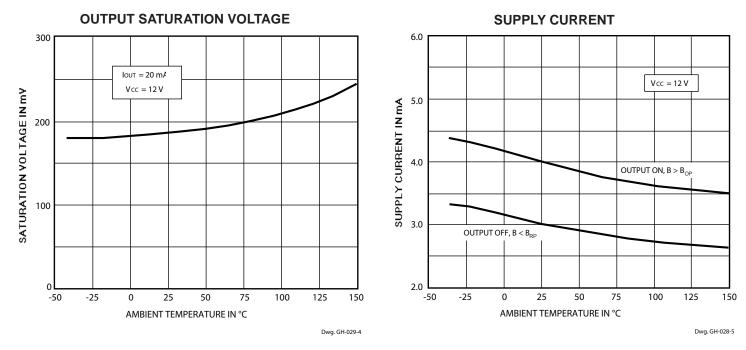
TYPICAL OPERATING CHARACTERISTICS as a function of temperature

A3283 SWITCH POINTS 200 160 OPERATE POINT 120 80 SWITCH POINTS IN GAUSS 40 Vcc = 4.5 V 0 -40 -80 -120 RELEASE POINT -160 -200 -25 50 75 125 -50 0 25 100 150 AMBIENT TEMPERATURE IN °C Dwg. GH-026-6

Allegro

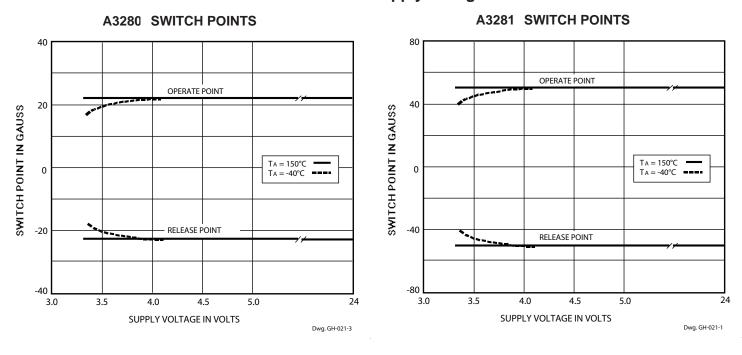
A3280, A3281 and A3283

Chopper-Stabilized, Precision Hall-Effect Latches



TYPICAL OPERATING CHARACTERISTICS as a function of temperature (cont'd)

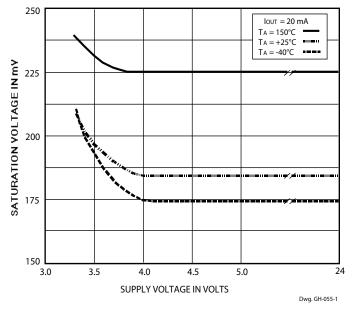
TYPICAL OPERATING CHARACTERISTICS as a function of supply voltage





TYPICAL OPERATING CHARACTERISTICS as a function of supply voltage (cont'd)





 SUPPLY CURRENT

 8.0

 7.0

 6.0

 5.0

 6.0

 5.0

 6.0

 7.0

 6.0

 7.0

 6.0

 7.0

 6.0

 7.0

 6.0

 7.0

 6.0

 7.0

 6.0

 7.0

 6.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0

 7.0



7.0

SUPPLY VOLTAGE IN VOLTS

8.0

9.0

10

11

Dwg. GH-058-4

12

SUPPLY CURRENT IN mA

3.0

4.0

5.0

6.0

FUNCTIONAL DESCRIPTION

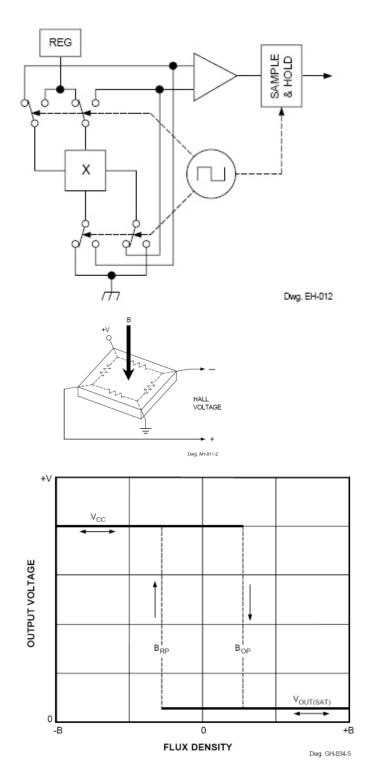
Chopper-Stabilized Technique. The Hall element can be considered as a resistor array similar to a Wheatstone bridge. A large portion of the offset is a result of the mismatching of these resistors. These devices use a proprietary dynamic offset cancellation technique, with an internal high-frequency clock to reduce the residual offset voltage of the Hall element that is normally caused by device overmolding, temperature dependencies, and thermal stress. The chopper-stabilizing technique cancels the mismatching of the resistor circuit by changing the direction of the current flowing through the Hall plate using CMOS switches and Hall voltage measurement taps, while maintaing the Hallvoltage signal that is induced by the external magnetic flux. The signal is then captured by a sample-and-hold circuit and further processed using low-offset bipolar circuitry. This technique produces devices that have an extremely stable quiescent Hall output voltage, are immune to thermal stress, and have precise recoverability after temperature cycling. This technique will also slightly degrade the device output repeatability. A relatively high sampling frequency is used in order that faster signals can be processed.

More detailed descriptions of the circuit operation can be found in: Technical Paper STP 97-10, *Monolithic Magnetic Hall Sensing Using Dynamic Quadrature Offset Cancellation* and Technical Paper STP 99-1, *Chopper-Stabilized Amplifiers With A Track-and-Hold Signal Demodulator*.

Operation. The output of these devices switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point threshold (B_{OP}). After turn-on, the output is capable of sinking 25 mA and the output voltage is $V_{OUT(SAT)}$. Note that the device latches; that is, a south pole of sufficient strength towards the branded surface of the device will turn the device on; removal of the south pole will leave the device on. When the magnetic field is reduced below the release point (B_{RP}), the device output goes high (turns off). The difference in the magnetic operate and release points is the hysteresis (B_{hys}) of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise.

Powering up in the absence of a magnetic field (less than B_{OP} and higher than B_{RP}) will allow an indeterminate output state. The correct state is warranted after the first excursion beyond B_{OP} or B_{RP} .

It is strongly recommended that an external bypass capacitor





A3280, A3281 and A3283

Chopper-Stabilized, Precision Hall-Effect Latches

APPLICATIONS INFORMATION

be connected (in close proximity to the Hall element) between the vices, Application Note 27703.1 noise generated by the chopper-stabilization technique.

a ring magnet. Other methods of operation, such as linear magnets, are possible.

Extensive applications information for Hall-effect devices is available in:

• Hall-Effect IC Applications Guide, Application Note 27701;

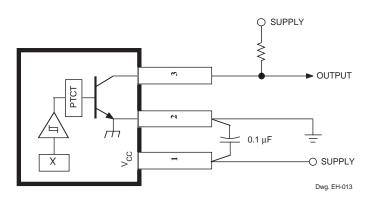
• Guidelines for Designing Subassemblies Using Hall-Effect De-

supply and ground of the device to reduce both external noise and More detailed descriptions of the chopper-stabilized circuit operation can be found in:

The simplest form of magnet that will operate these devices is • Monolithic Magnetic Hall Sensing Using Dynamic Quadrature Offset Cancelation, Technical Paper STP 97-10; and

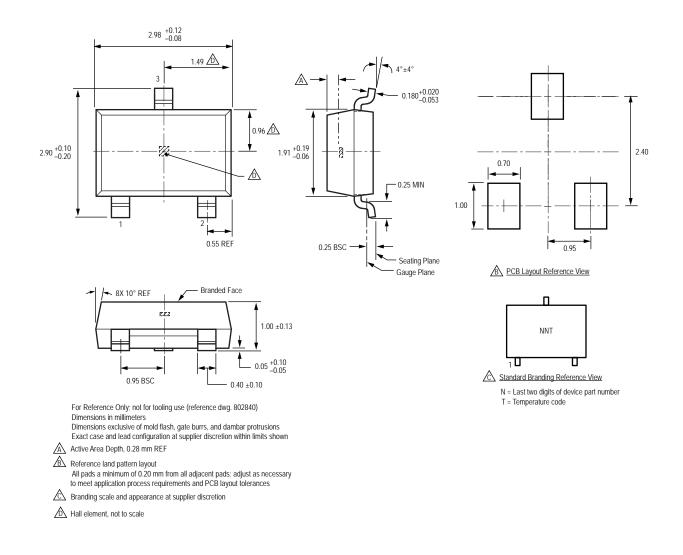
> Chopper-Stabilized Amplifiers With A Track-and-Hold Signal Demodulator, Technical Paper STP 99-1. All are provided at

> > www.allegromicro.com



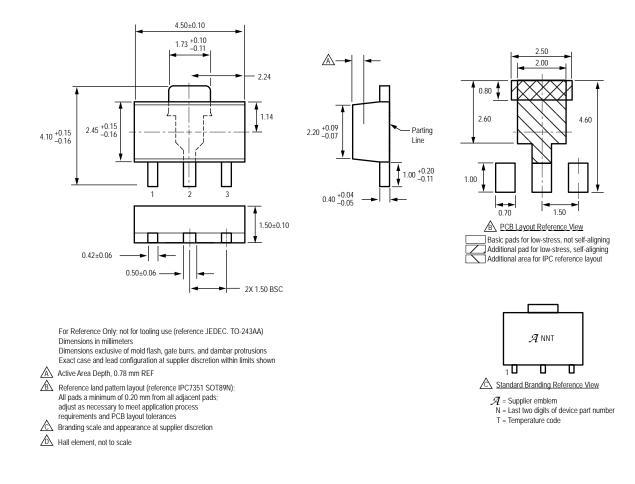


Package LH, 3-Pin (SOT-23W)



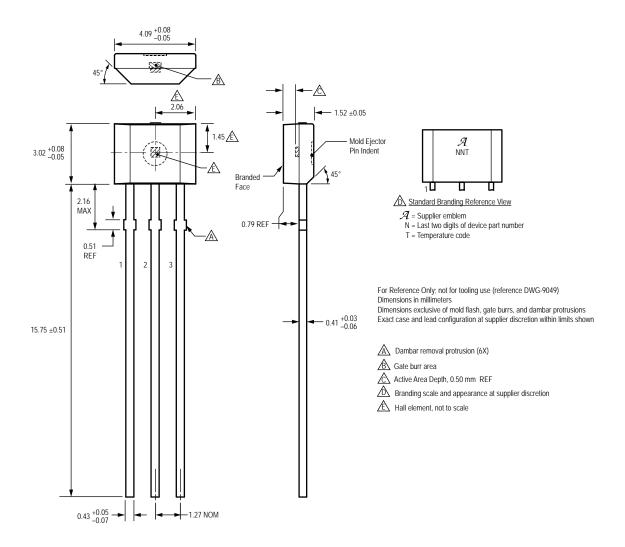


Package LT, 3-Pin SOT89









Copyright ©2002-2010, Allegro MicroSystems, Inc.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

Allegro's products are not to be used in life support devices or systems, if a failure of an Allegro product can reasonably be expected to cause the failure of that life support device or system, or to affect the safety or effectiveness of that device or system.

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringement of patents or other rights of third parties which may result from its use.

For the latest version of this document, visit our website: www.allegromicro.com

